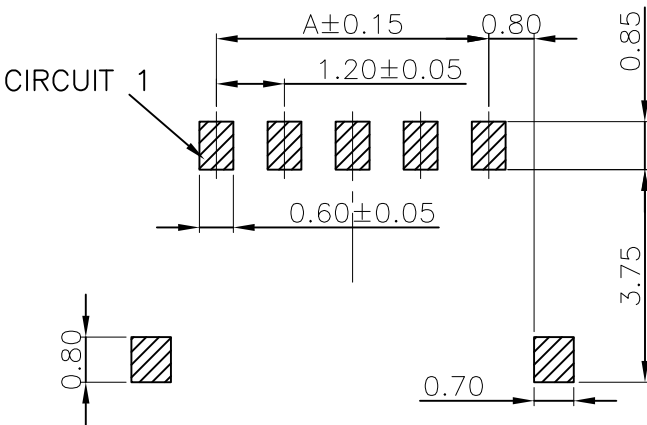
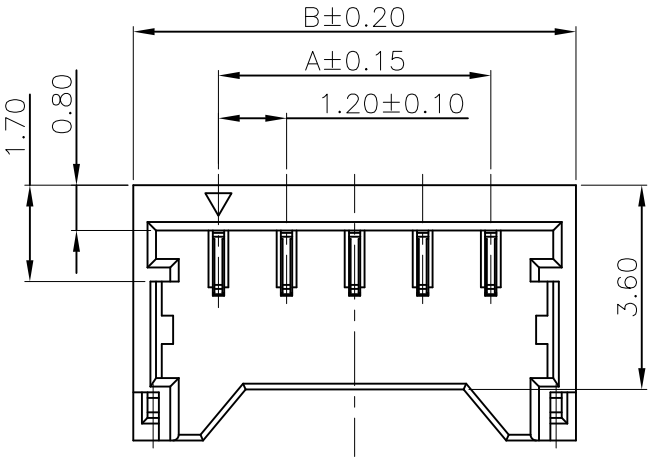


The product using material and processing must conform to the "WL-PZ-001"HSF technical standard control requirements

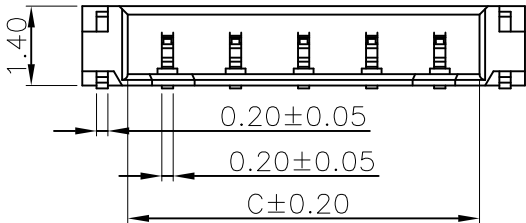
RoHS+HF

NOTE:
1.MATERIAL SPECIFICATION:
1-1.HOUSING: LCP,UL94V-0
1-2.CONTACTS: PHOSPHOR BRONZE
1-3.SOLDER TABS: PHOSPHOR BRONZE
2.PLATING SPECIFICATION:
2-1.CONTACTS:
TIN/GOLD FLASH PLATED OVER ALL.
2-2.SOLDER TABS:
Matte Tin PLATED OVER ALL.
3.MECHANICAL PERFORMANCE:
3-1.RETENTIVITY FORCE: 0.05KGF/pin min
3-2.DURABILITY: 10 CYCLES.
4.ELECTRICAL PERFORMANCE:
4-1.CURRENT RATING: 1.5A AC/DC
RATED VOLTAGE : 50V AC/DC
4-2.CONTACT RESISTANCE: 20 mΩ MAX
4-3.INSULATION RESISTANCE: 100MΩ Min
4-4.DIELECTRIC WITHSTANDING : 500V
5.ENVIRONMENTAL PERFORMANCE:
5-1.OPERATING TEMPERATURE: -25°C~+85°C.
6.PACKAGE SPEC: REEL
7.P/N: A1201 W 9-1 XX 2 X X 0
SERIES NO: _____
CONNECTOR: _____
W-WAFER
ANGLE: _____
9-90°
ROW NO: _____
1-SINGLE ROW
PIN Q'PY: _____
02~07、10PIN
COLOR:
A-BLACK
S-NATURE
PLATING:
A-ALL AU G/F
C-BRIGHT TIN
D-MATTE Tin
TERMIPOINT:
2-SMT

Circuit	Dimensions (mm)		
	A	B	C
02	---	4.20	2.65
03	2.40	5.40	3.85
04	3.60	6.60	5.05
05	4.80	7.80	6.25
06	6.00	9.00	7.45
07	7.20	10.20	8.65
10	10.80	13.80	12.25



P.C.B LAYOUT
(TOP VIEW)



REV.	REVISION RECORD	DATE		GENERAL TOLERANCES		SCALE: 1:1	NAME	DATE	PART.NO: A1201W9-1XX2XX0	DWG.NO: ENDE05	
A0	NEW RELEASE	22.05.09		LINEAR	ANGLES	APPROVED	Wang_jr	23.9.19			
A1	PART NUMBER RENEWAL	23.9.19		0.0±0.35	X*REF±6°	DESIGNER	Han_Gao	23.9.19	TITLE: Pitch 1.20mm MX 90° SMT Single row Wafer		
				UNIT:mm	0.00±0.25	X°±3°	DRAWN	LanXuan_Hou		23.9.19	
			SIZE: A4	0.000±0.10	X°X' ±2°	REV: A1			SHEET: 1/2		

